Unit in mm

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

2 S K 2 4 6 7 - Y

HIGH POWER AMPLIFIER APPLICATION

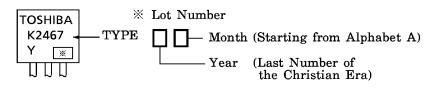
High Breakdown Voltage $: V_{DSS} = 180V$

High Forward Transfer Admittance : $|Y_{fs}| = 4.0S$ (Typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Drain-Source Voltage	$ m V_{DSS}$	180	V	
Gate-Source Voltage	v_{GSS}	±20	V	
Drain Current	I_{D}	9	A	
Drain Power Dissipation (Tc=25°C)	$P_{\mathbf{D}}$	80	W	
Channel Temperature	$\mathrm{T_{ch}}$	150	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$\mathbf{T_{stg}}$	-55~150	$^{\circ}\mathrm{C}$	

MARKING



ELECTRICAL CHARACTERISTICS (Ta = 25°C)

15.8±0.5 15.8±0.5 2.0 10-0.15 5.45±0.2 5.45±0.2 5.45±0.2	83.6±0.2 3.5 5.0±0.12 45±0.2 3.15-0.1
2. DI	ATE RAIN DURCE
JEDEC	_
EIAJ	_
TOSHIBA 2	2-16F1B

weight: 5.8g (1yp.)	t: 5.8g (Ty	7p.)
---------------------	-------------	------

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Drain Cut-Off Current	$I_{ m DSS}$	$V_{DS} = 180V, V_{GS} = 0$	_	_	1.0	mA
Gate Leakage Current	IGSS	$V_{DS} = 0, V_{GS} = \pm 20V$	_	_	±0.5	μ A
Drain-Source Breakdown Voltage	V _(BR) DSS	$I_{D} = 10 \text{mA}, V_{GS} = 0$	180	_	_	v
Drain-Source Saturation Voltage	V _{DS} (ON)	$V_{GS}=10V, I_{D}=6A$	_	2.5	5.0	V
Gate-Source Cut-off Voltage (Note)	V _{GS (OFF)}	$V_{DS} = 10V, I_{D} = 0.1A$	1.4	_	2.8	V
Forward Transfer Admittance	Y _{fs}	V_{DS} =10V, I_{D} =3A	_	4.0	_	s
Input Capacitance	Ciss	V_{DS} =30V, V_{GS} =0, f=1MHz	_	700	_	рF
Output Capacitance	Coss	V_{DS} =30V, V_{GS} =0, f=1MHz	_	150		рF
Reverse Capacitance	$\mathrm{c}_{\mathrm{rss}}$	$V_{DS} = 30V, V_{GS} = 0, f = 1MHz$	_	90		pF

 $(Note): V_{GS(OFF)} Classification$

This transistor is an electrostatic sensitive device.

Please handle with caution.

- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

 The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.